# 74ALVC16834A

18-bit registered driver with inverted register enable; 3-state

Rev. 2 — 21 November 2017 Product data sheet

## 1 General description

The 74ALVC16834A is an 18-bit registered driver. Data flow is controlled by active low output enable ( $\overline{OE}$ ), active low latch enable ( $\overline{LE}$ ) and clock inputs (CP).

When  $\overline{LE}$  is LOW, the A to Y data flow is transparent. When  $\overline{LE}$  is HIGH and CP is held at LOW or HIGH, the data is latched; on the LOW to HIGH transient of CP the A-data is stored in the latch/flip-flop.

When  $\overline{OE}$  is LOW the outputs are active. When  $\overline{OE}$  is HIGH, the outputs go to the high impedance OFF-state. Operation of the  $\overline{OE}$  input does not affect the state of the latch/flip-flop.

To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pull-up resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

#### 2 Features and benefits

- Wide supply voltage range from 1.2 V to 3.6 V
- CMOS low-power consumption
- Direct interface with TTL levels (2.7 V to 3.6 V)
- Current drive ± 24 mA at V<sub>CC</sub> = 3.0 V
- · MULTIBYTE flow-through standard pin-out architecture
- Low inductance multiple V<sub>CC</sub> and GND pins for minimum noise and ground bounce
- Output drive capability 50 Ω transmission lines at 85°C
- · Input diodes to accommodate strong drivers
- · Complies with JEDEC standards:
  - JESD8-5 (2.3 V to 2.7 V)
  - JESD8B/JESD36 (2.7 V to 3.6 V)
- ESD protection:
  - HBM ANSI/ESDA/JEDEC JS-001 exceeds 2000 V
  - CDM JESD22-C101E exceeds 1000 V

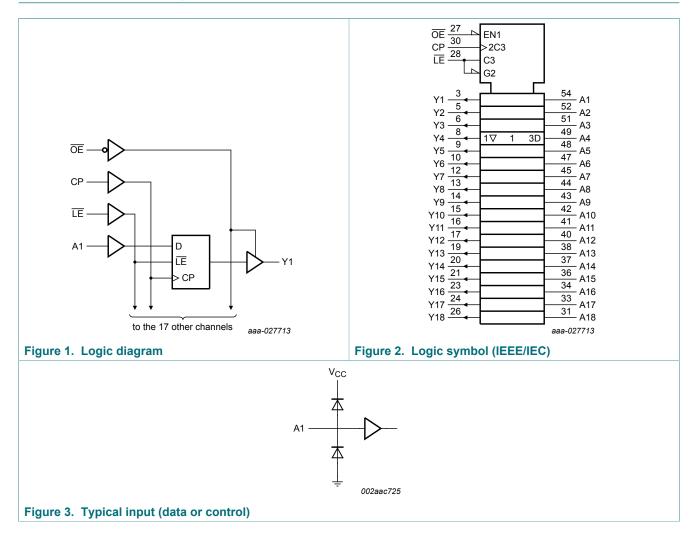


## 3 Ordering information

**Table 1. Ordering information** 

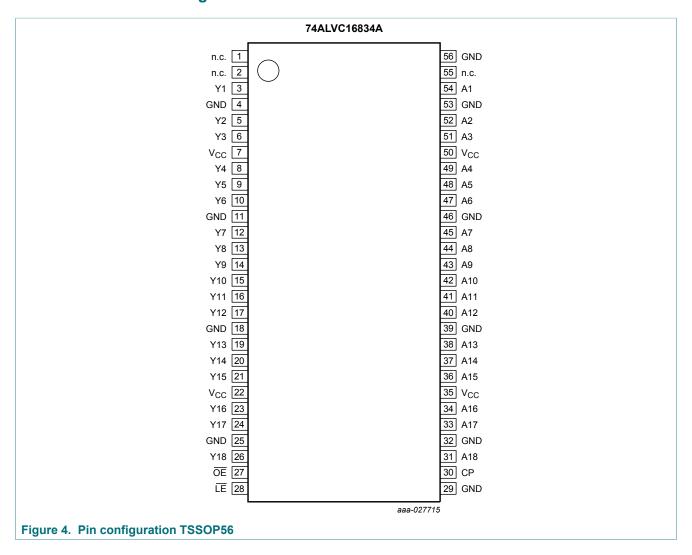
Type number	Package	Package							
	Temperature range	Name	Description	Version					
74ALVC16834ADGG	-40 °C to + 85 °C	TSSOP56	plastic thin shrink small outline package; 56 leads; body width 6.1 mm	SOT364-1					

## 4 Functional diagram



## 5 Pinning information

### 5.1 Pinning



### 5.2 Pin description

Table 2. Pin description

Symbol	Pin	Description
A1, A2, A3, A4, A5, A6, A7, A8, A9, A10, A11, A12, A13, A14, A15, A16, A17, A18	54, 52, 51, 49, 48, 47, 45, 44, 43, 42, 41, 40, 38, 37, 36, 34, 33, 31	data inputs
Y1, Y2, Y3, Y4, Y5, Y6, Y7, Y8, Y9, Y10, Y11, Y12, Y13, Y14, Y15, Y16, Y17, Y18	3, 5, 6, 8, 9, 10, 12, 13, 14, 15, 16, 17, 19, 20, 21, 23, 24, 26	data outputs
n.c.	1, 2, 55	no connected
<u>LE</u>	28	latch enable input (active LOW)
ŌĒ	27	output enable input (active LOW)
СР	30	clock pulse input (active rising edge)
GND	4, 11, 18, 25, 32, 39, 46, 53, 56	ground (0 V)
V <sub>CC</sub>	7, 22, 35, 50	supply voltage

## **Functional description**

Table 3. Function table [1]

Input	Input					
ŌĒ	LE	СР	An	Yn		
Н	X	X	X	Z		
L	L	X	L	L		
L	L	X	Н	Н		
L	Н	1	L	L		
L	Н	1	Н	Н		
L	Н	Н	X	Y <sub>0</sub> <sup>[2]</sup>		
L	Н	L	X	Y <sub>0</sub> [3]		

<sup>[1]</sup> H = HIGH voltage level;

L = LOW voltage level;

X = don't care;

Z = high-impedance OFF-state;

 $<sup>\</sup>uparrow$  = LOW-to-HIGH clock transition.

<sup>[2]</sup> Y<sub>0</sub> = Output level before the indicated steady-state input conditions were established, provided that CP is high before LE goes low.

[3] Y<sub>0</sub> = Output level before the indicated steady-state input conditions were established.

## **Limiting values**

#### Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>CC</sub>	supply voltage			-0.5	+4.6	V
VI	input voltage	For control pins	[1]	-0.5	+4.6	V
		For An pins	[1]	-0.5	V <sub>CC</sub> + 0.5	V
Vo	output voltage		[1]	-0.5	V <sub>CC</sub> + 0.5	V
I <sub>IK</sub>	input clamping current	V <sub>I</sub> < 0 V		-50	-	mA
I <sub>OK</sub>	output clamping current	V <sub>O</sub> > V <sub>CC</sub> or V <sub>O</sub> < 0 V		-	±50	mA
I <sub>O(sink/</sub> source)	output sink or source current	$V_O = 0 V \text{ to } V_{CC}$		-	±50	mA
I <sub>CC</sub>	supply current			-	+100	mA
I <sub>GND</sub>	ground current			-100	-	mA
T <sub>stg</sub>	storage temperature			-65	+150	°C
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> = -40 °C to +85 °C	[2]	-	600	mW

 <sup>[1]</sup> The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
 [2] For TSSOP56 package: P<sub>tot</sub> derates linearly with 8 mW/K above 55 °C.

## **Recommended operating conditions**

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>CC</sub>	supply voltage	2.5 V range for maximum speed performance at 30 pF output load	2.3	-	2.7	V
		3.3 V range for maximum speed performance at 50 pF output load	3.0	-	3.6	V
		for low-voltage applications	1.2	-	3.6	V
VI	input voltage		0	-	V <sub>CC</sub>	V
Vo	output voltage		0	-	V <sub>CC</sub>	V
T <sub>amb</sub>	ambient temperature	operating in free-air	-40	-	+85	°C
Δt/ΔV input transition rise	V <sub>CC</sub> = 2.3 V to 3.0 V	-	-	20	ns/V	
	and fall rate	V <sub>CC</sub> = 3.0 V to 3.6 V	-	-	10	ns/V

### 9 Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ <sup>[1]</sup>	Max	Unit
V <sub>IH</sub>	HIGH-level input	V <sub>CC</sub> = 2.3 V to 2.7 V	1.7	1.2	-	V
	voltage	V <sub>CC</sub> = 2.7 V to 3.6 V	2.0	1.5	-	V
V <sub>IL</sub>	LOW-level input	V <sub>CC</sub> = 2.3 V to 2.7 V	-	1.2	0.7	V
	voltage	V <sub>CC</sub> = 2.7 V to 3.6 V	-	1.5	8.0	V
V <sub>OH</sub>	HIGH-level output	$V_I = V_{IH}$ or $V_{IL}$				
	voltage	$V_{CC}$ = 2.3 V to 3.6 V; $I_{O}$ = -100 $\mu A$	V <sub>CC</sub> - 0.2	V <sub>CC</sub>	-	V
		V <sub>CC</sub> = 2.3 V; I <sub>O</sub> = -6 mA	V <sub>CC</sub> - 0.3	V <sub>CC</sub> - 0.08	-	V
		V <sub>CC</sub> = 2.3 V; I <sub>O</sub> = -12 mA	V <sub>CC</sub> - 0.6	V <sub>CC</sub> - 0.26	-	V
		V <sub>CC</sub> = 2.7 V; I <sub>O</sub> = -12 mA	V <sub>CC</sub> - 0.5	V <sub>CC</sub> - 0.14	-	V
		V <sub>CC</sub> = 3.0 V; I <sub>O</sub> = -12 mA	V <sub>CC</sub> - 0.6	V <sub>CC</sub> - 0.09	-	V
		V <sub>CC</sub> = 3.0 V; I <sub>O</sub> = -24 mA	V <sub>CC</sub> - 1.0	V <sub>CC</sub> - 0.28	-	V
$V_{OL}$	LOW-level output	$V_I = V_{IH}$ or $V_{IL}$				
	voltage	$V_{CC}$ = 2.3 V to 3.6 V; $I_{O}$ = 100 $\mu$ A	-	GND	0.20	V
		V <sub>CC</sub> = 2.3 V; I <sub>O</sub> = 6 mA	-	0.07	0.40	V
		V <sub>CC</sub> = 2.3 V; I <sub>O</sub> = 12 mA	-	0.15	0.70	V
		V <sub>CC</sub> = 2.7 V; I <sub>O</sub> = 12 mA	-	0.14	0.40	V
		V <sub>CC</sub> = 3.0 V; I <sub>O</sub> = 24 mA	-	0.27	0.55	V
I <sub>I</sub>	input leakage current	$V_{CC}$ = 2.3 V to 3.6 V; $V_I$ = $V_{CC}$ or GND	-	0.1	5	μΑ
I <sub>OZ</sub>	OFF-state output current	$V_{CC}$ = 2.3 V to 3.6 V; $V_I$ = $V_{IH}$ or $V_{IL}$ ; $V_O$ = $V_{CC}$ or GND	-	0.1	10	μA
I <sub>CC</sub>	supply current	$V_{CC}$ = 2.3 V to 3.6 V; $V_I$ = $V_{CC}$ or GND; $I_O$ = 0 mA	-	0.2	40	μA
ΔI <sub>CC</sub>	additional supply current	$V_{CC}$ = 2.3 V to 3.6 V; $V_{I}$ = $V_{CC}$ - 0.6 V; $I_{O}$ = 0 mA	-	150	750	μΑ
C <sub>i</sub>	input capacitance		-	4.0	-	pF
Co	output capacitance		-	8.0	-	pF

<sup>[1]</sup> Typical values are measured at  $T_{amb}$  = 25 °C

## 10 Dynamic characteristics

#### **Table 7. Dynamic characteristics**

Voltages are referenced to GND (ground = 0 V). For test circuit, see Figure 11.

Symbol	Parameter	Conditions		Min	Typ <sup>[1]</sup>	Max	Unit
t <sub>pd</sub>	propagation delay	An to Yn; Figure 5	[2]				
		V <sub>CC</sub> = 2.3 V to 2.7 V		1.0	2.4	4.2	ns
	V <sub>CC</sub> = 2.7 V		1.0	2.7	4.0	ns	
		V <sub>CC</sub> = 3.0 V to 3.6 V		1.0	2.3	3.6	ns
		LE to Yn; Figure 6	[2]				
		V <sub>CC</sub> = 2.3 V to 2.7 V		1.0	2.8	5.0	ns
		V <sub>CC</sub> = 2.7 V		1.0	2.8	5.2	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V		1.0	2.6	4.5	ns
		CP to Yn; Figure 8	[2]				
		V <sub>CC</sub> = 2.3 V to 2.7 V		1.0	2.8	5.0	ns
		V <sub>CC</sub> = 2.7 V		1.0	2.7	4.9	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V		1.0	2.5	4.2	ns
t <sub>en</sub>	enable time	OE to Yn; Figure 10	[3]				
		V <sub>CC</sub> = 2.3 V to 2.7 V		1.0	2.2	4.0	ns
		V <sub>CC</sub> = 2.7 V		1.0	3.0	5.4	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V		1.0	2.3	4.4	ns
t <sub>dis</sub>	disable time	OE to Yn; Figure 10	[4]				
		V <sub>CC</sub> = 2.3 V to 2.7 V		1.0	2.0	-	ns
		V <sub>CC</sub> = 2.7 V		1.0	3.1	4.6	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V		1.0	2.8	4.1	ns
t <sub>w</sub>	pulse width	CP HIGH or LOW; V <sub>CC</sub> = 2.3 V to 3.6 V; Figure 8		2.0	-	-	ns
		LE HIGH; V <sub>CC</sub> = 2.3 V to 3.6 V; Figure 6		2.0	-	-	ns
t <sub>su</sub>	set-up time	An to CP; V <sub>CC</sub> = 2.3 V to 3.6 V; Figure 9		1.0	-	-	ns
		An to LE; V <sub>CC</sub> = 2.3 V to 3.6 V; Figure 7		1.5	-	-	ns
t <sub>h</sub>	hold time	An to CP; Figure 9					
		V <sub>CC</sub> = 2.3 V to 2.7 V		0.6	0.2	-	ns
		V <sub>CC</sub> = 2.7 V		0.6	0.3	-	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V		0.9	0.3	-	ns
		An to LE; Figure 7					
		V <sub>CC</sub> = 2.3 V to 2.7 V		1.4	0.4	-	ns
		V <sub>CC</sub> = 2.7 V		1.7	0.4	-	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V		1.4	0.3	-	ns

Symbol	Parameter	Conditions		Min	Typ <sup>[1]</sup>	Max	Unit
f <sub>max</sub>	maximum	CP; Figure 8					
	frequency	V <sub>CC</sub> = 2.3 V to 2.7 V		150	300	-	MHz
		V <sub>CC</sub> = 2.7 V		200	350	-	MHz
		V <sub>CC</sub> = 3.0 V to 3.6 V		150	300	-	MHz
C <sub>PD</sub>	power dissipation	per buffer; V <sub>I</sub> = GND to V <sub>CC</sub>	[5]				
	capacitance	transparent mode; output enabled		-	13	-	pF
		transparent mode; output disabled		-	3	-	pF
		clocked mode; output enabled		-	22	-	pF
		clocked mode; output disabled		-	15	-	pF

[1] Typical values are measured at  $T_{amb}$  = 25 °C

Typical values for  $V_{CC}$  = 2.3 V to 2.7 V are measured at  $V_{CC}$  = 2.5 V

Typical values for  $V_{CC}$  = 3.0 V to 3.6 V are measured at  $V_{CC}$  = 3.3 V

- $t_{\text{pd}}$  is the same as  $t_{\text{PHL}}$  and  $t_{\text{PLH}}$ .
- $t_{en}$  is the same as  $t_{PZH}$  and  $t_{PZL}$ .
- [4] t<sub>dis</sub> is the same as t<sub>PHZ</sub> and t<sub>PLZ</sub>.
   [5] C<sub>PD</sub> is used to determine the dynamic power dissipation (P<sub>D</sub> in μW): P<sub>D</sub> = C<sub>PD</sub> × V<sub>CC</sub><sup>2</sup> × f<sub>i</sub> × N +Σ(C<sub>L</sub> × V<sub>CC</sub><sup>2</sup> × f<sub>o</sub>) where:

f<sub>i</sub> = input frequency in MHz;

 $f_0$  = output frequency in MHz;

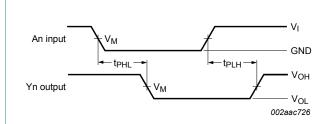
C<sub>L</sub> = output load capacitance in pF;

V<sub>CC</sub> = supply voltage in V;

N = number of inputs switching;

 $\sum (C_L \times V_{CC}^2 \times f_0) = \text{sum of outputs.}$ 

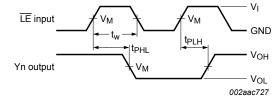
#### 10.1 Waveforms and test circuit



Measurement points are given in Table 8.

 $V_{\text{OL}}$  and  $V_{\text{OH}}$  are typical voltage output drop that occur with the output load.

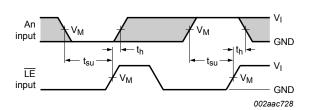
Figure 5. Input (An) to output (Yn) propagation delay



Measurement points are given in Table 8.

 $V_{OL}$  and  $V_{OH}$  are typical voltage output drop that occur with the output load.

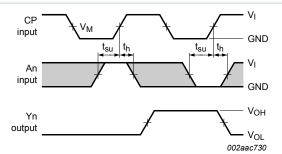
Figure 6. LE input pulse width, LE input to Yn output propagation delays



Measurement points are given in Table 8.

The shaded areas indicate when the input is permitted to change for predictable output performance.

Figure 7. Data set-up and hold times, An input to  $\overline{\text{LE}}$  input

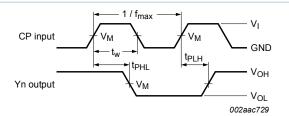


Measurement points are given in Table 8.

 $\ensuremath{V_{OL}}$  and  $\ensuremath{V_{OH}}$  are typical voltage output drop that occur with the output load.

The shaded areas indicate when the input is permitted to change for predictable output performance.

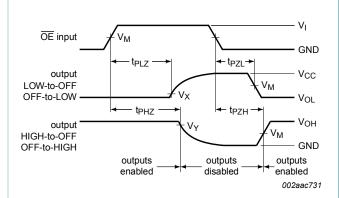
Figure 9. Data set-up and hold times, An input to CP input



Measurement points are given in Table 8.

 $V_{\text{OL}}$  and  $V_{\text{OH}}$  are typical voltage output drop that occur with the output load.

Figure 8. CP to Yn propagation delays, clock pulse width, and maximum clock frequency



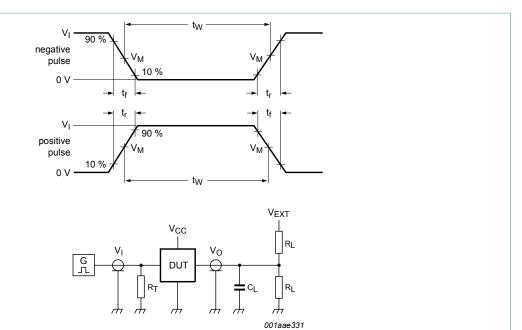
Measurement points are given in Table 8.

 $\ensuremath{V_{\text{OL}}}$  and  $\ensuremath{V_{\text{OH}}}$  are typical voltage output drop that occur with the output load.

Figure 10. 3-state enable and disable times

Table 8. Measurement points

Supply voltage	Input		Output				
V <sub>CC</sub>	VI	V <sub>M</sub>	V <sub>M</sub>	V <sub>X</sub>	V <sub>Y</sub>		
≤ 2.3 V	V <sub>CC</sub>	0.5 x V <sub>CC</sub>	0.5 x V <sub>CC</sub>	V <sub>OL</sub> + 0.15 V	V <sub>OH</sub> - 0.15 V		
2.3 V to 2.7 V	V <sub>CC</sub>	0.5 x V <sub>CC</sub>	0.5 x V <sub>CC</sub>	V <sub>OL</sub> + 0.15 V	V <sub>OH</sub> - 0.15 V		
2.7 V	2.7 V	1.5 V	1.5 V	V <sub>OL</sub> + 0.3 V	V <sub>OH</sub> - 0.3 V		
3.0 V to 3.6 V	2.7 V	1.5 V	1.5 V	V <sub>OL</sub> + 0.3 V	V <sub>OH</sub> - 0.3 V		



Test data is given in Table 9.

Definitions for test circuit:

R<sub>L</sub> = Load resistance.

 $C_L$  = Load capacitance including jig and probe capacitance.

 $R_T$  = Termination resistance should be equal to output impedance  $Z_0$  of the pulse generator.

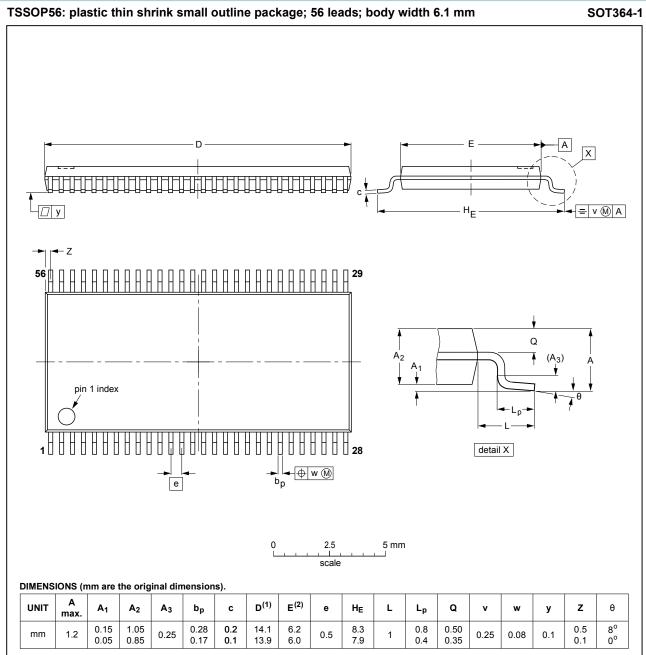
 $V_{EXT}$  = External voltage for measuring switching times.

Figure 11. Test circuit for measuring switching times

Table 9. Test data

Supply voltage	Input		Load V <sub>EXT</sub>			Load		
V <sub>CC</sub>	VI	t <sub>r</sub> , t <sub>f</sub>	CL	R <sub>L</sub>	t <sub>PLH</sub> , t <sub>PHL</sub>	t <sub>PLZ</sub> , t <sub>PZL</sub>	t <sub>PHZ</sub> , t <sub>PZH</sub>	
≤ 2.3 V	V <sub>CC</sub>	≤ 2.0 ns	30 pF	500 Ω	open	2 × V <sub>CC</sub>	GND	
2.3 V to 2.7 V	V <sub>CC</sub>	≤ 2.0 ns	30 pF	500 Ω	open	2 × V <sub>CC</sub>	GND	
2.7 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	open	2 × V <sub>CC</sub>	GND	
3.0 V to 3.6 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	open	2 × V <sub>CC</sub>	GND	

## 11 Package outline



#### Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	RENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE
SOT364-1		MO-153			<del>99-12-27</del> 03-02-19

Figure 12. Package outline SOT364-1 (TSSOP56)

74ALVC16834A

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### 12 Abbreviations

#### Table 10. Abbreviations

Acronym	Description
CDM	Charged Device Model
CMOS	Complementary Metal-Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
НВМ	Human Body Model
TTL	Transistor-Transistor Logic

## 13 Revision history

#### Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes		
74ALVC16834A v.2	20171121	Product data sheet	-	74ALVC16834A v.1		
Modifications:	<ul> <li>The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia.</li> <li>Legal texts have been adapted to the new company name where appropriate.</li> </ul>					
74ALVC16834A v.1	20000314	Product specification	-	74ALVC16834 v.1		
74ALVC16834 v.1	20000104	Product specification	-	-		

## 14 Legal information

#### 14.1 Data sheet status

Document status <sup>[1][2]</sup>	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- Please consult the most recently issued document before initiating or completing a design.
- The term 'short data sheet' is explained in section "Definitions". [2] [3]
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### **Contents**

1	General description	1
2	Features and benefits	1
3	Ordering information	
4	Functional diagram	
5	Pinning information	
5.1	Pinning	3
5.2	Pin description	
6	Functional description	
7	Limiting values	
8	Recommended operating conditions	
9	Static characteristics	
10	Dynamic characteristics	
10.1	Waveforms and test circuit	
11	Package outline	
12	Abbreviations	
13	Revision history	
14	Legal information	

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